

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

[1] (currently amended) A phosphorus-containing silazane composition comprising a polyalkylsilazane and at least one phosphorus compound in an organic solvent wherein said phosphorus compound is ~~selected from a compound of formula $(RO)_3P=O$ where each R, which may be the same or different, represents a trisubstituted silyl group in which the substituents have 1 to 4 carbon atoms or a compound of formula $-R^1_2P=N-$ where each R^1 , which may be the same or different, represents an alkoxy group having 1 to 5 carbon atoms~~ tris(trimethylsilyl)phosphate.

Claims [2] to [11] (canceled)

[12] (currently amended) A semiconductor device comprising a phosphorus-containing siliceous film comprising 0.5 to 10 atomic% of phosphorus and being produced by baking a film of a phosphorus-containing silazane composition comprising a polyalkylsilazane and at least one phosphorus compound in an organic solvent wherein said phosphorus compound is tris(trimethylsilyl)phosphate according to claim 8 as an interlayer insulation film.